

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	WEN-YU LIN	02/10/2022
	KAI-MING YANG	02/10/2022
	CHEN-HAO LIN	02/11/2022
	PU-JU LIN	02/11/2022
	CHENG-TA KO	02/11/2022
	CHIN-SHENG WANG	02/11/2022
	GUANG-HWA MA	02/18/2022
	TZYY-JANG TSENG	02/22/2022
RECEIVING PARTY DATA		
Name:	UNIMICRON TECHNOLOGY CORP.	
Street Address:	NO. 179, SHANYING RD., GUISHAN DIST.,	
City:	TAOYUAN CITY	
State/Country:	TAIWAN	
Postal Code:	333	
PROPERTY NUMBERS Total: 1		
	Property Type	Number
	Application Number:	17684421
CORRESPONDENCE DATA		
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NAME OF SUBMITTER:	JOSEPH SU	
SIGNATURE:	/Joseph Su/	

DATE SIGNED:	03/08/2022
Total Attachments: 4 source=117572_del-assn#page1.tif source=117572_del-assn#page2.tif source=117572_del-assn#page3.tif source=117572_del-assn#page4.tif	

**DECLARATION AND ASSIGNMENT
FOR UTILITY OR DESIGN PATENT APPLICATION**

☒ Declaration Submitted With Initial Filing

OR

☐ Declaration Submitted After Initial Filing (surcharge 37 CFR 1.16(f) required)

(Title of the Invention)

**CIRCUIT BOARD STRUCTURE AND MANUFACTURING METHOD
THEREOF**

As a below named inventor (hereinafter designated as the undersigned), I hereby
declare that:

This declaration is directed to:

☒ The attached application,

OR

☐ United States Application Number or PCT International application number

_____ Filed on _____

The above-identified application was made or authorized to be made by me.

I believe I am the original inventor or an original joint inventor of a claimed invention in
the application.

The undersigned hereby acknowledge that any willful false statement made in this
declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more
than five (5) years, or both.

**DECLARATION AND ASSIGNMENT
FOR UTILITY OR DESIGN PATENT APPLICATION**

WHEREAS, the undersigned has invented certain new and useful improvements described in the application identified.

WHEREAS, 1. Unimicron Technology Corp.
of No. 179, Shanying Rd., Guishan Dist., Taoyuan City 333, Taiwan
(R.O.C.)

hereinafter referred to as ASSIGNEE, is desirous of acquiring the undersigned's interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by the undersigned, the undersigned has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said rights, title and interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said the undersigned had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

The undersigned further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

**DECLARATION AND ASSIGNMENT
FOR UTILITY OR DESIGN PATENT APPLICATION**

Signature: Wen-Yu Lin Date: 2022/2/10

Legal Name of Sole or First Inventor: **Wen-Yu Lin**

Residence: Taichung City, Taiwan

Mailing Address: No. 343, Dazhou Rd., Shengang Dist., Taichung City 429, Taiwan (R.O.C.)

Signature: Kai-Ming Yang Date: 2022/2/10

Legal Name of Additional Joint Inventor, if any: **Kai-Ming Yang**

Residence: Hsinchu County, Taiwan

Mailing Address: 8F., No. 28, Sec. 1, Fuxing 3rd Rd., Zhubei City, Hsinchu County 302, Taiwan
(R.O.C.)

Signature: Chen-Hao Lin Date: 2022/2/11

Legal Name of Additional Joint Inventor, if any: **Chen-Hao Lin**

Residence: Keelung City, Taiwan

Mailing Address: 2F., No. 39-1, Ln. 249, Yuanyuan Rd., Nuannuan Dist., Keelung City 205, Taiwan
(R.O.C.)

Signature: Pu-Ju Lin Date: 2022/2/11

Legal Name of Additional Joint Inventor, if any: **Pu-Ju Lin**

Residence: Hsinchu City, Taiwan

Mailing Address: 15F.-5, No. 518, Puding Rd., East Dist., Hsinchu City 300, Taiwan (R.O.C.)

**DECLARATION AND ASSIGNMENT
FOR UTILITY OR DESIGN PATENT APPLICATION**

Signature: Cheng-Ta Ko Date: 2022/2/11

Legal Name of Additional Joint Inventor, if any: **Cheng-Ta Ko**

Residence: Taipei City, Taiwan

Mailing Address: No.44-4, Yongkang St., Da'an Dist., Taipei City 106, Taiwan (R.O.C.)

Signature: Chin-Sheng Wang Date: 2022/2/11

Legal Name of Additional Joint Inventor, if any: **Chin-Sheng Wang**

Residence: Taoyuan City, Taiwan

Mailing Address: c/o No. 179, Shanying Rd., Guishan Dist., Taoyuan City 333, Taiwan (R.O.C.)

Signature: Guang-Hwa Ma Date: 2022/2/18

Legal Name of Additional Joint Inventor, if any: **Guang-Hwa Ma**

Residence: Hsinchu City, Taiwan

Mailing Address: 6F., No. 153, Ln. 89, Sec. 1, Guangfu Rd., East Dist., Hsinchu City 300, Taiwan
(R.O.C.)

Signature: Tzyy-Jang Tseng Date: 2022/02/22

Legal Name of Additional Joint Inventor, if any: **Tzyy-Jang Tseng**

Residence: Taoyuan City, Taiwan

Mailing Address: c/o No. 179, Shanying Rd., Guishan Dist., Taoyuan City 333, Taiwan (R.O.C.)